

Title (en)
Process for depositing an enamel layer

Title (de)
Verfahren zum Abscheiden einer Emailierschicht

Title (fr)
Procédé pour déposer une couche d'émail

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Abstract (en)
[origin: EP0505967A1] In a process for depositing an enamel layer, a workpiece (1) having workpiece surfaces (3) to be enamelled is immersed in an enamel slip bath (5), a direct voltage being applied between a cathode assigned to the enamel slip bath (5) and the workpiece (1) as anode in order to deposit an enamel layer on the workpiece surfaces (3). According to the invention, to modify the thickness of an enamel layer which is deposited on a particular workpiece surface (13), the particular workpiece surface (13) has a screening element (15) arranged at a distance.
<IMAGE>

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